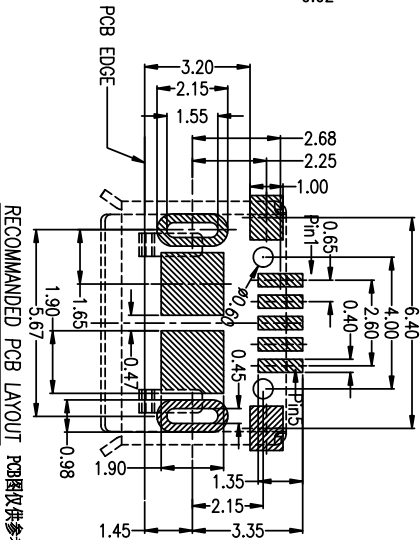
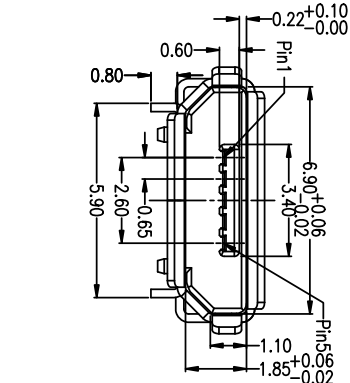
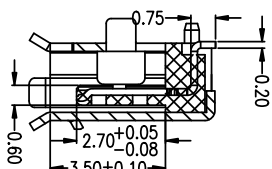
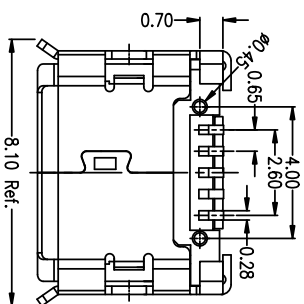
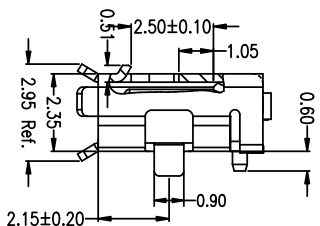
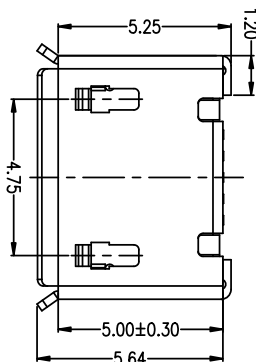
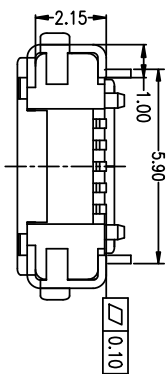


ROHS

MAPX	MODIFICATION	DRW	DATE



- Note:
- 1.Material:
- 1.1 Housing: LCP J1L94V-0
 - 1.2 Contact: copper alloy,t=0.20mm contact area Au flash plating;
 - 1.3 Shell:copper or SUS304,t=0.25mm Sn plating 60U" min.
- 2.Specification:
- 2.1 Current rating:1.5PIN 1.8A Max/2,3,4PIN 1A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min.
 - 2.7 Temperature range: -30°C~80°C
 - 2.8 Solderability: 90% area min;

5	GND
4	ID
3	D+
2	D-
1	VBUS
	PIN NAME
	PIN ASSIGNMENT

产品图
Shenzhen Jing Tuojin Electronics Co., Ltd.

公差一览表		制图		林属升		制图料号		920-052A2021S10113	
TOLERANCE UNLESS OTHERWISE		DRAWINGS		审核		产品名称		NICO SS 8脚USB插板 9脚边插板有后盖加焊脚	
X	±0.35	X	±5.°	郭治富	CHD	比例	1:1	日期	2016-09-09
X	±0.25	X	±2.°	核推	APPD	SCALE		DATE	
XX	±0.20	XX	±1.°	黄国荣		DATE		角法	
.XXX	±0.15	.XXX	±0.5°			DATE		VER	A0